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9. A laminate produced in accordance with the process of claim 4.

10. A heat spreader for an electronic component comprising a plurality of flexible graphite sheets laminated into a unitary article, wherein the thermal anisotropic ratio of the article is at least about 70.
11. The heat spreader of claim 10 wherein the thermal anisotropic ratio of the article is at least about 90.
12. The heat spreader of claim 10 wherein the laminate is formed by laminating flexible sheets of compressed particles of exfoliated graphite with a suitable adhesive.
13. The heat spreader of claim 12 wherein the adhesive comprises a pressure sensitive or thermally activated adhesive.
14. A heat pipe for an electronic component comprising a plurality of flexible graphite sheets laminated into a unitary article, wherein the thermal anisotropic ratio of the article is at least about 70.
15. The heat pipe of claim 14 wherein the thermal anisotropic ratio of the article is at least about 90.
16. The heat pipe of claim 14 wherein the laminate is formed by laminating flexible sheets of compressed particles of exfoliated graphite with a suitable adhesive.
17. The heat pipe of claim 16 wherein the adhesive comprises a pressure sensitive or thermally activated adhesive.

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